

As a below named inventor, I hereby declare that:

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of subject matter (process, machine, manufacture, or composition of matter, or an improvement thereof) which is claimed and for which a patent is sought by way of the application entitled "A Structure and Method For Linking Scatter/Gather List Segments For Host Adapters" which

- I hereby state that I have reviewed and understand the contents of the specification, including the claims of the application entitled "A Structure and Method For Linking Scatter/Gather List Segments For Host Adapters", as amended by any amendment referred to above.

I acknowledge the duty to disclose information known to me which is material to patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application on which priority is claimed.

| Prior Foreign Application(s) | | | Priority Claimed |
|------------------------------|-----------|------------------------|------------------|
| NA | | | [] Yes [] No |
| (Number) | (Country) | (Day/Month/Year Filed) | |
| NA | | | [] Yes [] No |
| (Number) | (Country) | (Day/Month/Year Filed) | |
| NA | | | [] Yes [] No |
| (Number) | (Country) | (Day/Month/Year Filed) | |

